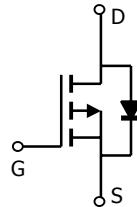
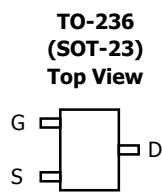




AO3407

P-Channel Enhancement Mode Field Effect Transistor

General Description	Features
<p>The AO3407 uses advanced trench technology to provide excellent $R_{DS(ON)}$ with low gate charge. This device is suitable for use as a load switch or in PWM applications.</p>	<p>V_{DS} (V) = -30V I_D = -4.1 A $R_{DS(ON)} < 52\text{m}\Omega$ ($V_{GS} = -10\text{V}$) $R_{DS(ON)} < 87\text{m}\Omega$ ($V_{GS} = -4.5\text{V}$)</p>



Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	-30	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ^A	I_D	-4.1	A
$T_A=70^\circ\text{C}$		-3.5	
Pulsed Drain Current ^B	I_{DM}	-20	
Power Dissipation ^A	P_D	1.4	W
$T_A=70^\circ\text{C}$		1	
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	°C

Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient ^A	$R_{\theta JA}$	65	90	°C/W
Steady-State		85	125	°C/W
Maximum Junction-to-Lead ^C	$R_{\theta JL}$	43	60	°C/W

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D=-250\mu\text{A}, V_{GS}=0\text{V}$	-30			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=-24\text{V}, V_{GS}=0\text{V}$	$T_J=55^\circ\text{C}$	-1	-5	μA
I_{GSS}	Gate-Body leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm20\text{V}$			±100	nA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=-250\mu\text{A}$	-1	-1.8	-3	V
$I_{\text{D(ON)}}$	On state drain current	$V_{GS}=-4.5\text{V}, V_{DS}=-5\text{V}$	-10			A
$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{GS}=-10\text{V}, I_D=-4.1\text{A}$	$T_J=125^\circ\text{C}$	40.5	52	$\text{m}\Omega$
				57	73	
g_{FS}	Forward Transconductance	$V_{DS}=-5\text{V}, I_D=-4\text{A}$	5.5	8.2		S
V_{SD}	Diode Forward Voltage	$I_S=-1\text{A}, V_{GS}=0\text{V}$		-0.77	-1	V
I_S	Maximum Body-Diode Continuous Current				-2.2	A
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=-15\text{V}, f=1\text{MHz}$		700		pF
C_{oss}	Output Capacitance			120		pF
C_{rss}	Reverse Transfer Capacitance			75		pF
R_g	Gate resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$		10		Ω
SWITCHING PARAMETERS						
Q_g	Total Gate Charge (10V)	$V_{GS}=-4.5\text{V}, V_{DS}=-15\text{V}, I_D=-4\text{A}$		14.3		nC
Q_g	Total Gate Charge (4.5V)			7		nC
Q_{gs}	Gate Source Charge			3.1		nC
Q_{gd}	Gate Drain Charge			3		nC
$t_{\text{D(on)}}$	Turn-On Delay Time	$V_{GS}=-10\text{V}, V_{DS}=-15\text{V}, R_L=3.6\Omega, R_{\text{GEN}}=3\Omega$		8.6		ns
t_r	Turn-On Rise Time			5		ns
$t_{\text{D(off)}}$	Turn-Off Delay Time			28.2		ns
t_f	Turn-Off Fall Time			13.5		ns
t_{rr}	Body Diode Reverse Recovery Time	$I_F=-4\text{A}, dI/dt=100\text{A}/\mu\text{s}$		27		ns
Q_{rr}	Body Diode Reverse Recovery Charge	$I_F=-4\text{A}, dI/dt=100\text{A}/\mu\text{s}$		15		nC

A: The value of R_{0JA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$. The value in any given application depends on the user's specific board design. The current rating is based on the $t \leq 10\text{s}$ thermal resistance rating.

B: Repetitive rating, pulse width limited by junction temperature.

C. The R_{0JA} is the sum of the thermal impedance from junction to lead R_{0JL} and lead to ambient.

D. The static characteristics in Figures 1 to 6,12,14 are obtained using 80 μs pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$. The SOA curve provides a single pulse rating.